

# Ferroelectric thin film fabrication by direct UV-lithography

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Ferroelectric films with high values of ferroelectricity, piezoelectricity and dielectricity, like lead-zirconate-titanate films (PZT,  $\text{PbZr}_{0.52}\text{Ti}_{0.48}\text{O}_3$ ) with perovskite structure, are widely used in the fields of sensors, energy harvesting, capacitors and FERAMs [1,2,3]. In this paper a novel, very easy way to produce micro patterned lead-zirconate-titanate ceramic thin films on silicon substrates by direct UV-lithography is shown.

Therefore a sol based on methacrylic acid was developed to generate photosensitive metal organic PZT precursor gel films. This sol was spincoated on silicon wafers and dried afterwards to obtain photosensitive gel films. These PZT xerogel films were patterned using conventional UV-lithography equipment and developed afterwards with organic solvents. The resulting patterned gel films were pyrolyzed and crystallized in air via rapid thermal annealing (RTA) in order to obtain crystalline ceramic PZT thin films. The samples were analyzed by XRD technique and SEM-images. Micro patterned, crack free, crystalline PZT thin films were obtained by this method.

The presented process has several advantages over other methods using photopolymerizable monomers for directly UV-photopatternable PZT films [4,5,6]. The sol synthesis is much more simple. No sophisticated techniques, like the use of inert gas atmosphere, are needed. Also higher resolutions in the lower  $\mu\text{m}$ -range and crack free ceramic thin films were achieved.

Figure 1 shows schematically the synthesis of the developed sol for direct UV-lithography. Methacrylic acid was used as photopolymerizable monomer, which is able to dissolve the needed metal precursors lead acetate, zirconium and titanate alkoxides. As UV-photoinitiator a diphenyl-benzoylphosphine oxide was added. This basic sol was then diluted with 2-methoxyethanol as it lowers the viscosity of the sol, which makes it well processible by spin-coating, and secondly stabilizes the sol. This sol is used to produce photosensitive gel films and these films can be patterned by UV-lithography.

An overview of the film deposition and patterning process is shown in figure 2. After the lithographic steps the resulting preceramic xerogel films (see figure 3) were pyrolyzed and crystallized by rapid thermal annealing. Figure 4 shows SEM-images of the ceramic microstructured thin PZT films. The films are polycrystalline, fine grained, crack free and 50-60 nm thick. Phase transition to the desired perovskite phase during thermal annealing of the PZT film was investigated by XRD measurements (see figure 5). The desired polycrystalline perovskite structure is formed at temperatures around 650 °C; below this temperature the phase transition from the pyrochlore phase to the desired perovskite phase was not completed.

This simple method unifies deposition and patterning steps. The needed metal organic sol can be used like a normal photoresist and hence this method can be easily used with existing cleanroom infrastructure. This method is an interesting alternative to today's mostly used patterning processes like photoresist lift-off or etching. The expansion of this method to mostly all oxide ceramics should be possible as the proof of concept was demonstrated by patterning PZT.

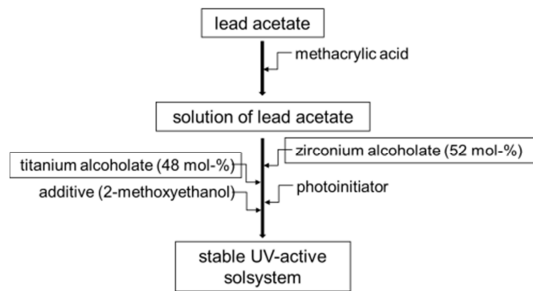


Figure 1: Schematic representation of the sol synthesis

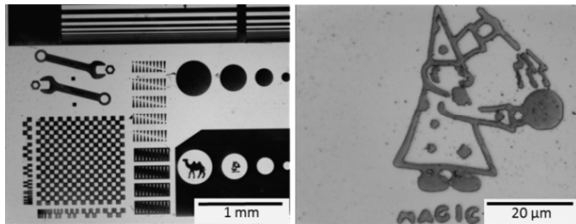


Figure 3: Fine patterned organo-PZT gel film, showing the high resolution of the process

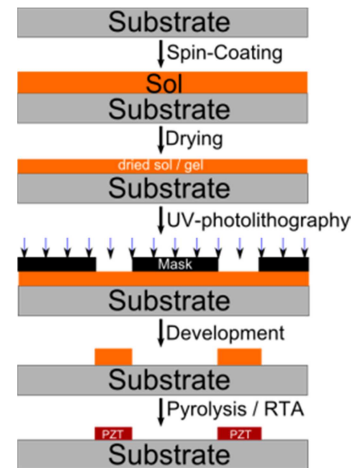


Figure 2: Scheme of the process chain

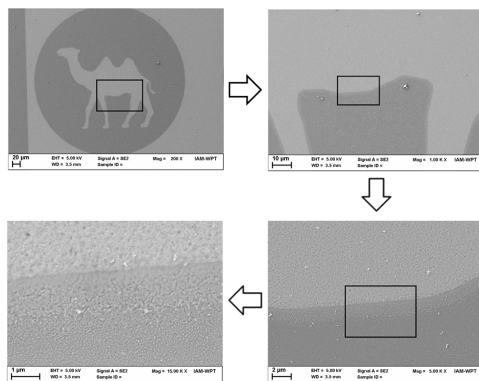


Figure 4: SEM-images showing the surface morphology of the pyrolyzed film

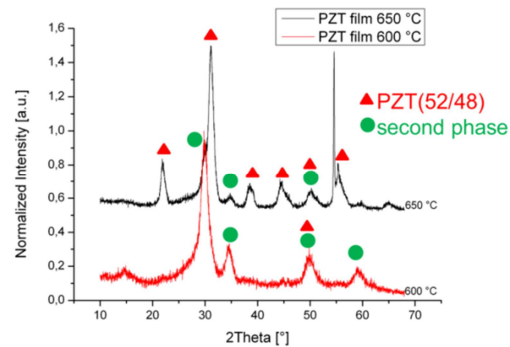


Figure 5: XRD patterns for PZT-films deposited on silicon substrates

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